

## *GL Silicon P-Channel Power MOSFET*

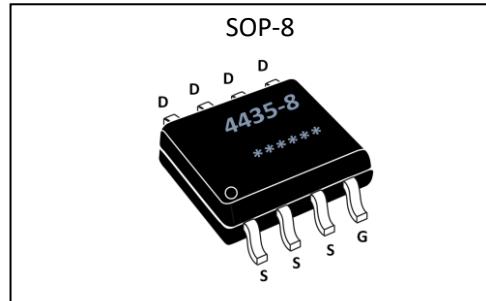
### **General Description:**

The GL4435-8 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. The package form is SOP-8, which accords with the RoHS standard.

$V_{DSS}$	-30	V
$I_D$	-9.1	A
$P_D$	3.1	W
$R_{DS(ON)}\text{type}$	20	$\text{m}\Omega$

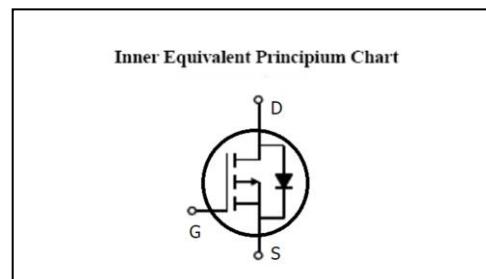
### **Features:**

- $R_{DS(ON)} < 30\text{m}\Omega$  @  $V_{GS}=10\text{V}$  (Typ20mΩ)
- High density cell design for ultra low  $R_{dson}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation



### **Applications:**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



### **Absolute (T<sub>c</sub>= 25°C unless otherwise specified):**

Symbol	Parameter	Rating	Units
$V_{DSS}$	Drain-to-Source Voltage	-30	V
$I_D$	Continuous Drain Current	-9	A
$I_{DM}$	Pulsed Drain Current	-50	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$P_D$	Power Dissipation	3.1	W
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	155, -55 to 155	°C



# GL4435-8

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**Electrical Characteristics** ( $T_c = 25^\circ\text{C}$  unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$V_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-30	--	--	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS}=-30\text{V}, V_{GS}=0\text{V}, T_a=25^\circ\text{C}$	--	--	-1.0	$\mu\text{A}$
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+20\text{V}$	--	--	0.1	$\mu\text{A}$
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20\text{V}$	--	--	-0.1	$\mu\text{A}$

ON Characteristics <sup>a3</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=-10\text{V}, I_D=-9.1\text{A}$	--	20	30	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}, I_D=-6.9\text{A}$		25	40	$\text{m}\Omega$
$V_{GS(\text{TH})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1.0	--	-3.0	V
Pulse width $t_p \leq 380\mu\text{s}, \delta \leq 2\%$						

Dynamic Characteristics <sup>a4</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$g_{fs}$	Forward Transconductance	$V_{DS}=-15\text{V}, I_D=-9.1\text{A}$	10	--	--	S
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}$	--	1600	--	pF
$C_{oss}$	Output Capacitance	$f=1.0\text{MHz}$	--	350	--	
$C_{rss}$	Reverse Transfer Capacitance		--	300	--	

Resistive Switching Characteristics <sup>a4</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(\text{ON})}$	Turn-on Delay Time	$V_{DD}=-15\text{V}, I_D=-1\text{A}$	--	10	--	ns
$t_r$	Rise Time		--	15	--	
$t_{d(\text{OFF})}$	Turn-Off Delay Time		--	110	--	
$t_f$	Fall Time		--	70	--	
$Q_g$	Total Gate Charge	$V_{DD}=-15\text{V}, I_D=-9.1\text{A}$	--	30	--	nC
$Q_{gs}$	Gate to Source Charge		--	5.5	--	
$Q_{gd}$	Gate to Drain ( "Miller" )Charge		--	8	--	



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### Source-Drain Diode Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$I_S$	Continuous Source Current <sup>a2</sup> (Body Diode)		--	--	-9.1	A
$V_{SD}$	Diode Forward Voltage <sup>a3</sup>	$I_S = -2.1A, V_{GS} = 0V$	--	--	-1.2	V

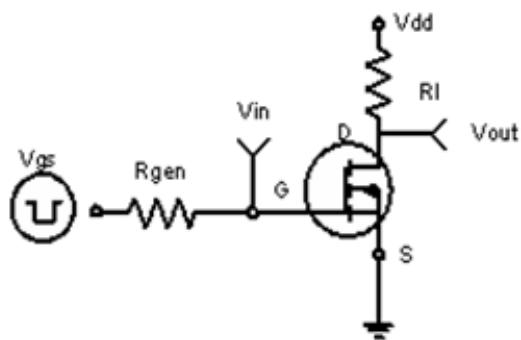
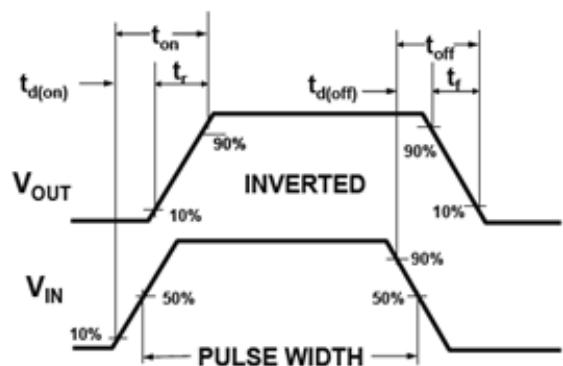
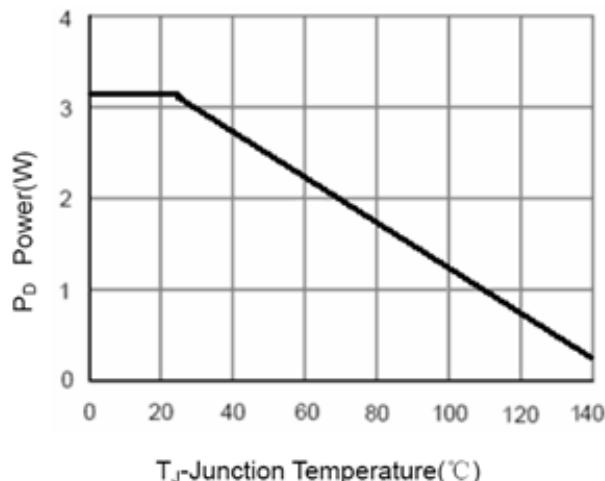
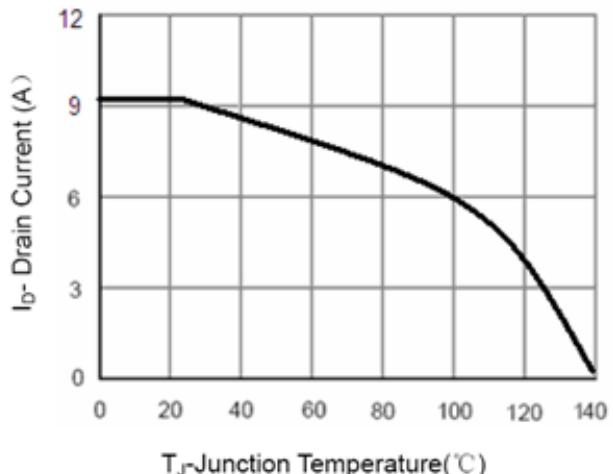
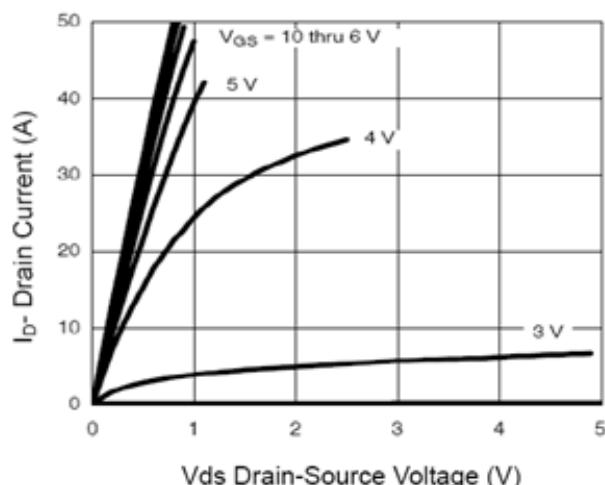
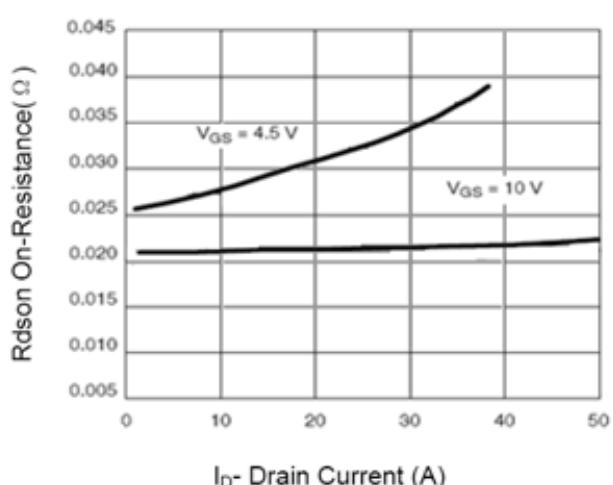
Symbol	Parameter	Typ.	Units
$R_{\theta JC}$	Junction-to-Case <sup>a2</sup>	40	°C/W

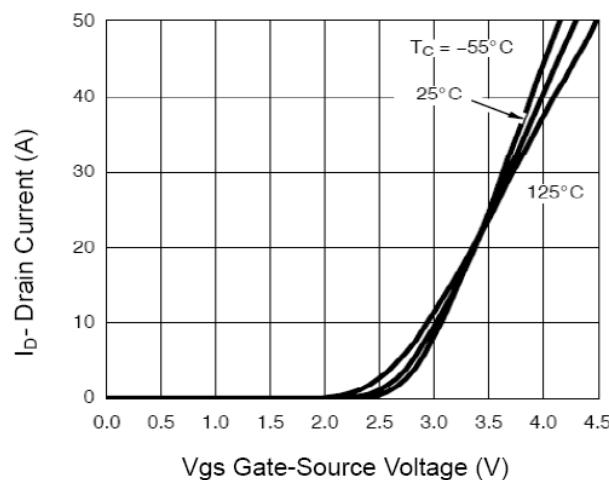
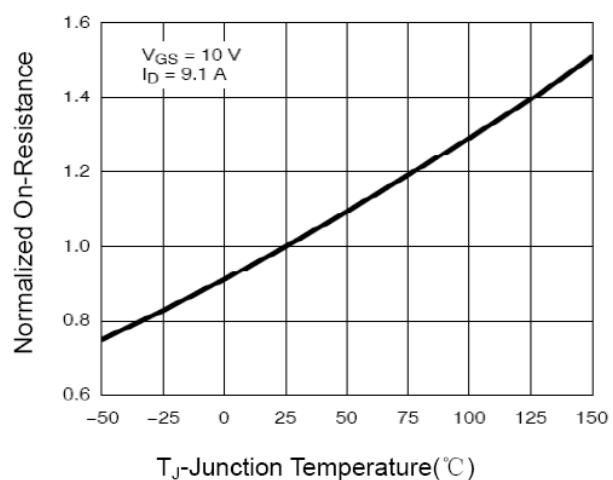
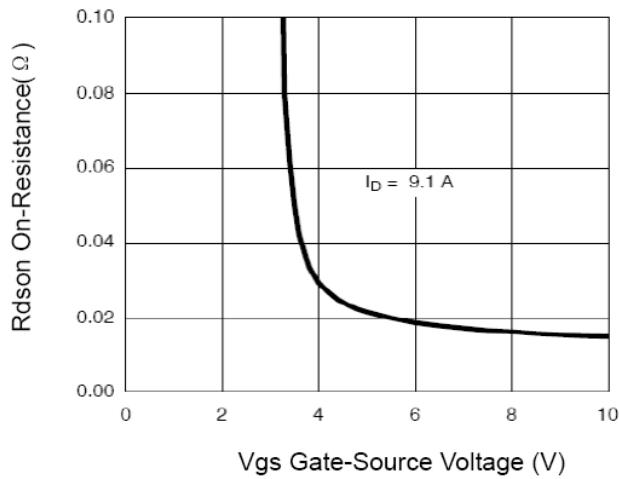
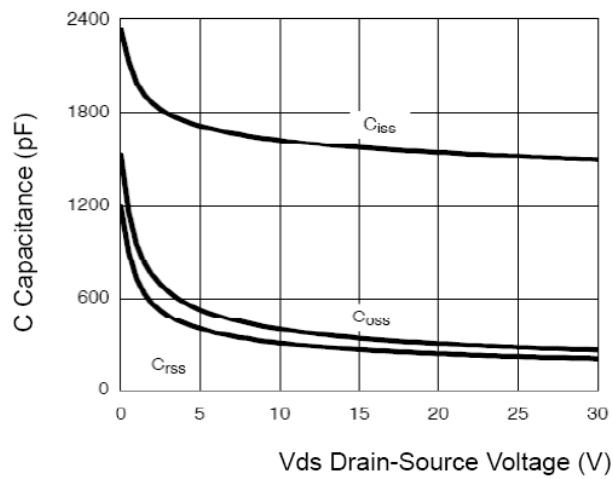
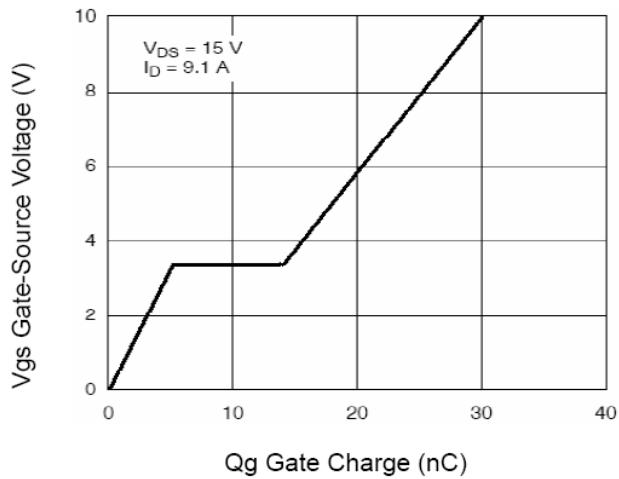
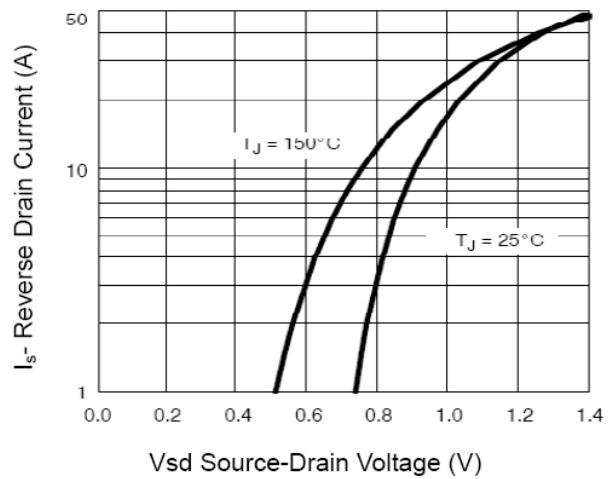
<sup>a1</sup>: Repetitive Rating: Pulse width limited by maximum junction temperature.

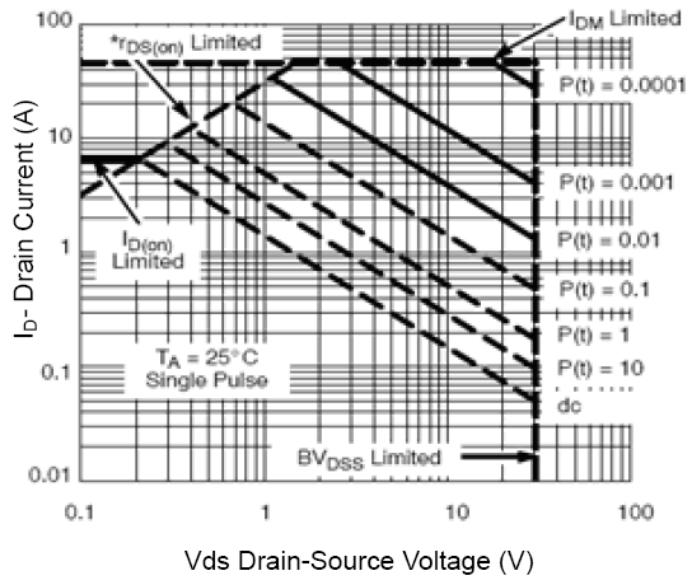
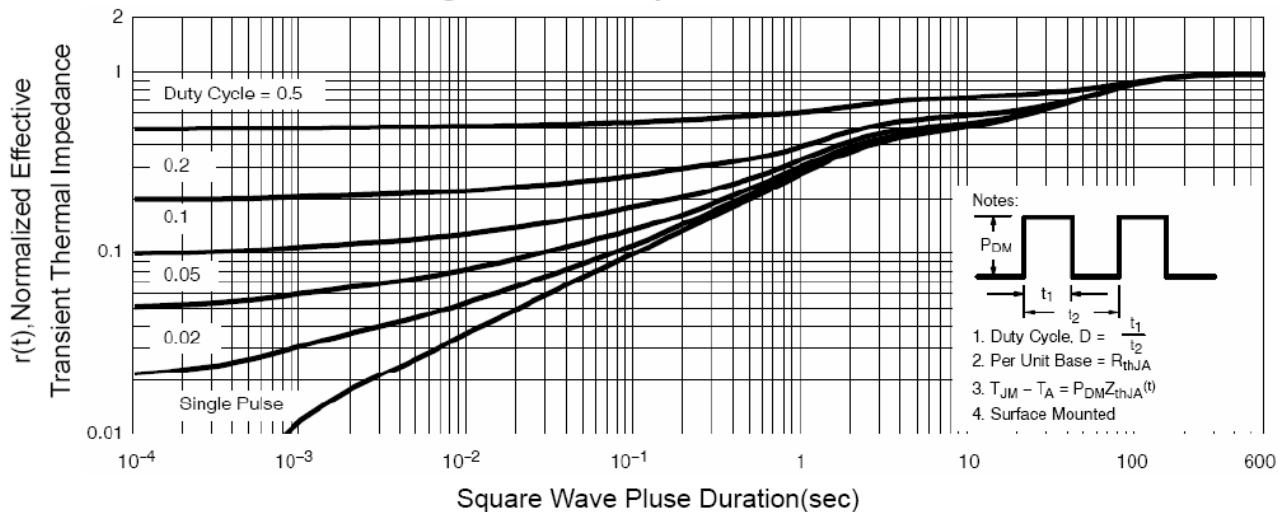
<sup>a2</sup>: Surface Mounted on FR4 Board,  $t \leq 10\text{sec}$ .

<sup>a3</sup>: Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

<sup>a4</sup>: Guaranteed by design, not subject to production

**Test circuit & Thermal Characteristics**

**Figure 1:Switching Test Circuit**

**Figure 2:Switching Waveforms**

**Figure 3 Power Dissipation**

**Figure 4 Drain Current**

**Figure 5 Output Characteristics**

**Figure 6 Drain-Source On-Resistance**

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**Figure 7 Transfer Characteristics**

**Figure 8 Drain-Source On-Resistance**

**Figure 9  $R_{DS(on)}$  vs  $V_{GS}$** 

**Figure 10 Capacitance vs  $V_{DS}$** 

**Figure 11 Gate Charge**

**Figure 12 Source-Drain Diode Forward**

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**Figure 13 Safe Operation Area**

**Figure 14 Normalized Maximum Transient Thermal Impedance**